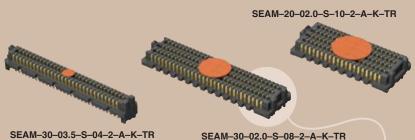


(1,27mm) .050'

**SEAM SERIES** 



# HIGH SPEED/HIGH DENSITY OPEN PIN FIELD

Single-Ended Signaling

Differential Pair Signaling

or contact sig@samtec.com

PLATING

**OPTION** 

= 10µ"

(0,25µm)

Gold on

Gold on

contact area

Matte Tin on

# **SPECIFICATIONS**

For complete specifications and recommended PCB layouts see www.samtec.com?SEAM

Insulator Material:

Black LCP
Contact Material:
Copper Alloy Solder Charge:

95.5% Sn, 3.8% Ag, 0.7% Cu (Tin/Lead also available. Call Samtec.)

Operating Temp Range: -55°C to +125°C

Plating: Au or Sn over 50μ" (1,27μm) Ni Contact Resistance:

 $5.5~\mathrm{m}\Omega$ Working Voltage:

9

8 8

8

8

8

8

8

8

8

8

8

8

8

8

9

8

8

RoHS Compliant: Yes Lead-Free Solderable: Yes

Industry



with SamArray®. Samples recommended. Low Insertion/ Extraction Forces 7mm Stack Height Rated @ 3dB Insertion Loss

9.5 GHz / 19 Gbps 10.5 GHz / 21 Gbps Performance data for other stack heights and complete test data available at www.samtec.com?SEAM

5, 8 and 10 row footprint compatible

CURRENT RATING AMBIENT SEAM/SEAF TEMP 20°C 2.3A 40°C 2A 60°C 1.75A 95°C 1.14A

> 30 ADJACENT POSITIONS POWERED

charges

PISMO 2 VITA 47 VITA 57

otocols

Fibre Channel Rapid 1/0 PCI Express® SATA Infiniband

Download app notes at www.samtec.com/appnote Contact SIG @ samtec.com for questions on protocols

#### NO. PINS SEAM PER ROW

-10, –15, –20,

-30, –40, –50

10 only ávailablé in 04 row)

-15 only available in 10 row

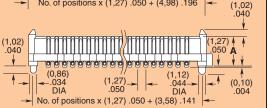
**LEAD** STYLE from chart

**LEAD** 

STYLE

NO. OF	В		
ROWS	P P		
-04	(7,06) .278		
-05, -06	(9,60) .378		
-08	08 (12,14) .478		
-10	(14,68) .578		

solder tail 0.050 .050 No. of positions x (1,27) .050 + (4,98) .196(1,02) .040



-04=Four Rows

NO. OF

**ROWS** 

(-06.5 not ontact area available) Matte Tin on solder tail -05 =Five Rows = 30µ" (0,76µm) (-06.5 not available)

> -06=Six Rows (-06.5 not available)

=Eight Rows -10 =Ten Rows

-08

LEAD STYLE	Α	
-02.0	(4,60) .181	
-03.0	(5,59) .220	
-03.5	(6,10) .240	
-06.5	(6,40) .252	
-07.0	(9,60) .378	
-09.0	(11,60) .457	
-11.0	(13,60) .535	

-2 Lead-Free Solder Charge

SOLDER

**TYPE** 

= Alignment Pins (Required. Arrays will not self-center on solder pads)

= Polyimide film Pick & Place Pad

–TR =Tape & Reel

### **ALSO AVAILABLE**

Rugged solder crimp option. Call Samtec.

MATED HEIGHTS							
SEAM	SEAF LEAD STYLE						
LEAD STYLE	-05.0	-06.0	-06.5	-07.5	-08.0		
-02.0	7mm	8mm	8.5mm	9.5mm	10mm		
-03.0	8mm	9mm	9.5mm	10.5mm	11mm		
-03.5	8.5mm	9.5mm	10mm	11mm	11.5mm		
-06.5	11.5mm	12.5mm	13mm	14mm	14.5mm		
-07.0	12mm	13mm	13.5mm	14.5mm	15mm		
-09.0	14mm	15mm	15.5mm	16.5mm	17mm		
-11.0	16mm	17mm	17.5mm	18.5mm	19mm		

# DIFFERENTIAL

(1,27) .050 (1,27) ( ) ( ) ( )		ARRAY	PAIR COUNT
	0000	40x8	80
	$\bullet \bullet \circ \circ$	40x6	60
<b>—</b> ••	0000	30x10	75
Ċ	PAIR		60
ARRAY	COUNT	30x6	45
50x10	125	20x10	50
50x8	100	20x8	40
40x10	100	20x5	25

Note: Some sizes, styles and options are non-standard. non-returnable.

Due to technical progress, all designs, specifications and components are subject to change without notice.

WWW.SAMTEC.COM